

Vishay Siliconix

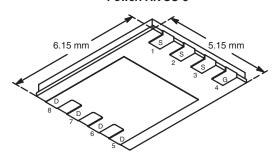
# N-Channel 75-V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A) <sup>a, g</sup>	Q <sub>g</sub> (Typ.)		
75	0.007 at V <sub>GS</sub> = 10 V	60	47.5 nC		

#### **FEATURES**

- Halogen-free
- TrenchFET® Power MOSFET
- 100 %  $R_g$  Tested
- 100 % UIS Tested

#### PowerPAK SO-8

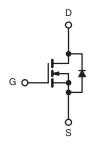


**Bottom View** 

Ordering Information: Si7174DP-T1-GE3 (Lead (Pb)-free and Halogen-free)

#### **APPLICATIONS**

- Primary Side Switch
- Synchronous Rectification



N-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V <sub>DS</sub>	75	v	
Gate-Source Voltage		$V_{GS}$	± 20		
	T <sub>C</sub> = 25 °C		60 <sup>g</sup>		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 70 °C	1 .	60 <sup>g</sup>		
Continuous Diain Current (1) = 130 G)	T <sub>A</sub> = 25 °C	l <sub>D</sub>	21 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		16.9 <sup>b, c</sup>	A	
Pulsed Drain Current	•	I <sub>DM</sub>	80		
Continuous Source Drain Diade Current	T <sub>C</sub> = 25 °C		60 <sup>g</sup>		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	5.2 <sup>b, c</sup>		
Single Pulse Avalanche Current L = 0.1 mH		I <sub>AS</sub>	40		
Single Pulse Avalanche Energy		E <sub>AS</sub>	80	mJ	
	T <sub>C</sub> = 25 °C		104		
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	66.5	W	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	l D	6.25 <sup>b, c</sup>	VV	
	T <sub>A</sub> = 70 °C		4.0 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	
Soldering Recommendations (Peak Tempera		260			

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, f</sup>	t ≤ 10 s	$R_{thJA}$	15	20	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	$R_{thJC}$	0.9	1.2	5/44	

#### Notes:

- a. Based on T<sub>C</sub> = 25 °C.
  b. Surface mounted on 1" x 1" FR4 board.
- d. See Solder Profile (<a href="http://www.vishay.com/ppg?73257">http://www.vishay.com/ppg?73257</a>). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

  Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

  Maximum under Steady State conditions is 54 °C/W.

- Package limited.

# **Si7174DP**

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	75			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA		76		\//0C
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_{J}$	I <sub>D</sub> = 250 μA		- 11		mV/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	2.5		4.5	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zava Cata Valtaga Drain Current	1	V <sub>DS</sub> = 75 V, V <sub>GS</sub> = 0 V			1	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 75 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			10	μΑ
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	40			Α
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A		0.0057	0.007	Ω
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, I_D = 10 \text{ A}$		34		S
Dynamic <sup>b</sup>				<b>'</b>		·
Input Capacitance	C <sub>iss</sub>			2770		
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		345		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			140		
Total Gate Charge	$Q_g$			47.5	72	
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 40 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$		13.8		nC
Gate-Drain Charge	$Q_{gd}$			14.4		
Gate Resistance	$R_g$	f = 1 MHz	0.3	1.2	2.4	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			16	30	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 40 V, $R_L$ = 10 $\Omega$		11	22	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D\cong$ 10 A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$		28	50	
Fall Time	t <sub>f</sub>			9	18	ns
Turn-On Delay Time	t <sub>d(on)</sub>			21	40	115
Rise Time	t <sub>r</sub>	$V_{DD}$ = 40 V, $R_L$ = 10 $\Omega$		11	22	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D\cong$ 10 A, $V_{GEN}$ = 8 V, $R_g$ = 6 $\Omega$		38	70	
Fall Time	t <sub>f</sub>			12	24	
<b>Drain-Source Body Diode Characteristi</b>	cs					
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			60	_
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				80	Α
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = 4 A		0.75	1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			47	95	ns
Body Diode Reverse Recovery Charge Q		I <sub>F</sub> = 10 A, di/dt = 100 A/μs, T <sub>J</sub> = 25 °C		103	210	nC
Reverse Recovery Fall Time	t <sub>a</sub>	i <sub>F</sub> = 10 A, αι/αι = 100 A/μs, 1 <sub>J</sub> = 25 C		36		ns
Reverse Recovery Rise Time	t <sub>b</sub>			11		

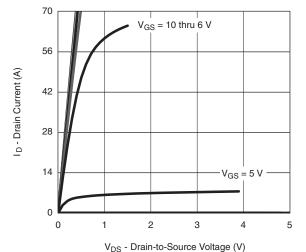
- a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 % b. Guaranteed by design, not subject to production testing.

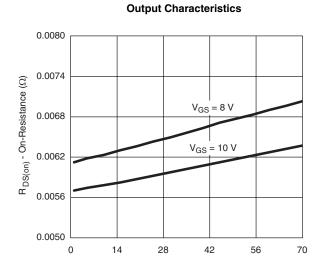
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



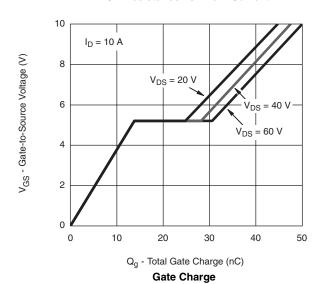
# Vishay Siliconix

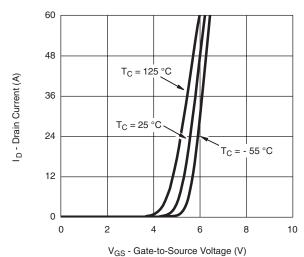
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



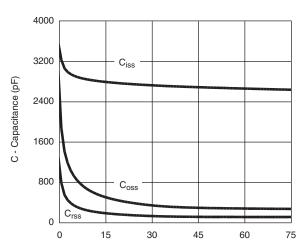


I<sub>D</sub> - Drain Current (A) **On-Resistance vs. Drain Current** 

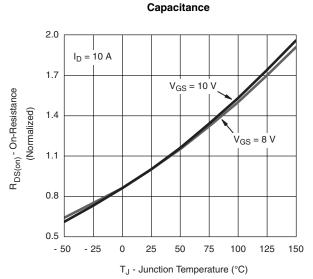




**Transfer Characteristics** 



V<sub>DS</sub> - Drain-to-Source Voltage (V)



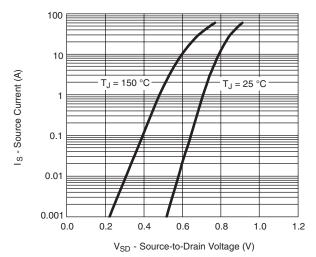
On-Resistance vs. Junction Temperature

# **Si7174DP**

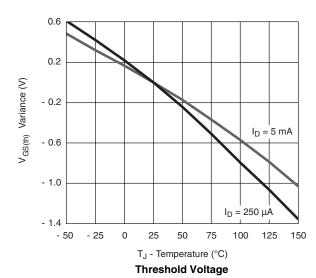
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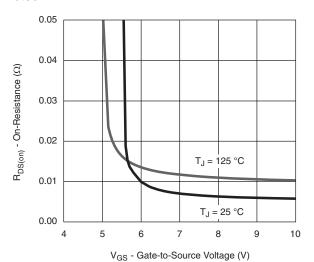
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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

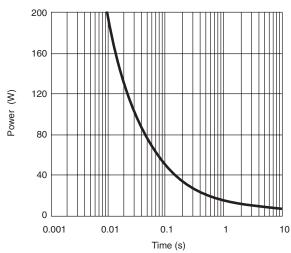


#### Source-Drain Diode Forward Voltage

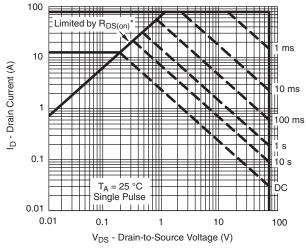




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



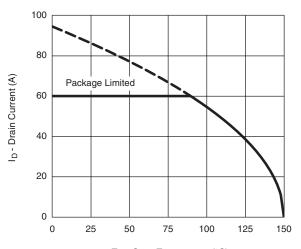
\* V<sub>GS</sub> > minimum V<sub>GS</sub> at which R<sub>DS(on)</sub> is specified

Safe Operating Area, Junction-to-Ambient



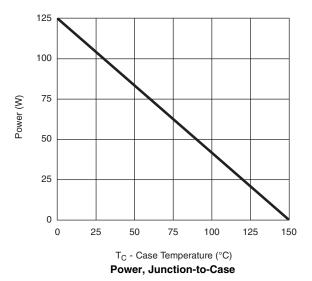
**Si7174DP** Vishay Siliconix

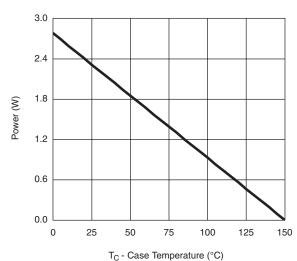
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



T<sub>C</sub> - Case Temperature (°C)

#### **Current Derating\***





Power, Junction-to-Ambient

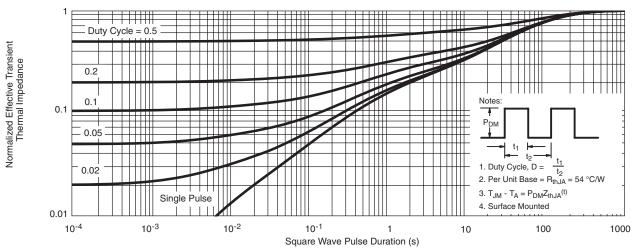
 $<sup>^*</sup>$  The power dissipation  $P_D$  is based on  $T_{J(max)} = 175$   $^{\circ}C$ , using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

## **Si7174DP**

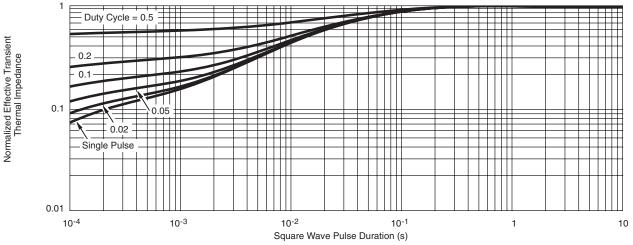
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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



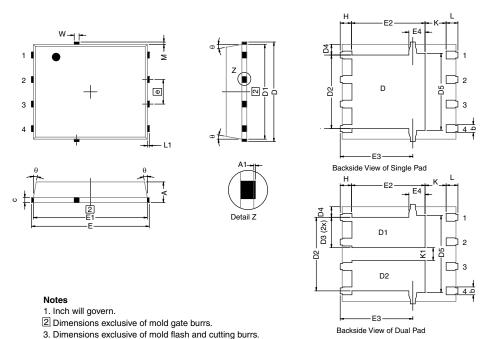
Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?69975">http://www.vishay.com/ppg?69975</a>.



DWG: 5881

# PowerPAK® SO-8, (Single/Dual)

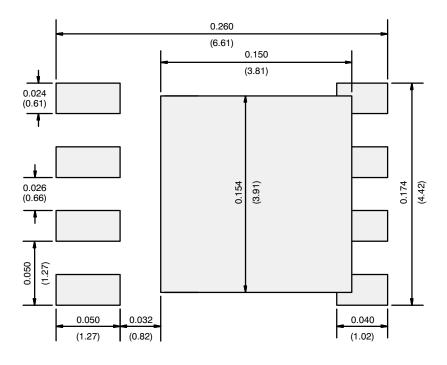


	MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.97	1.04	1.12	0.038	0.041	0.044	
A1		-	0.05	0	-	0.002	
b	0.33	0.41	0.51	0.013	0.016	0.020	
С	0.23	0.28	0.33	0.009	0.011	0.013	
D	5.05	5.15	5.26	0.199	0.203	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.56	3.76	3.91	0.140	0.148	0.154	
D3	1.32	1.50	1.68	0.052	0.059	0.066	
D4	0.57 typ. 0.0225 typ			0.0225 typ.			
D5		3.98 typ.		0.157 typ.			
E	6.05	6.15	6.25	0.238	0.242	0.246	
E1	5.79	5.89	5.99	0.228	0.232	0.236	
E2 (for AL product)	3.30	3.48	3.66	0.130	0.137	0.144	
E2 (for other product)	3.48	3.66	3.84	0.137	0.144	0.151	
E3	3.68	3.78	3.91	0.145	0.149	0.154	
E4 (for AL product)		0.58 typ. 0.023 typ.					
E4 (for other product)	0.75 typ.			0.030 typ.			
е	1.27 BSC			0.050 BSC			
K (for AL product)	1.45 typ.			0.057 typ.			
K (for other product)	1.27 typ.			0.050 typ.			
K1	0.56	=	=	0.022	-	=	
Н	0.51	0.61	0.71	0.020	0.024	0.028	
L	0.51	0.61	0.71	0.020	0.024	0.028	
L1	0.06	0.13	0.20	0.002	0.005	0.008	
θ	0°	-	12°	0°	-	12°	
W	0.15	0.25	0.36	0.006	0.010	0.014	
М	0.125 typ.			0.005 typ.			

Revison: 20-May-13 Document Number: 71655



### RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

Revision: 02-Oct-12 Document Number: 91000